



# **CPC1125N**

# 400V Normally-Closed Single-Pole 4-Pin SOP OptoMOS® Relay

Parameter	Rating	Units
Blocking Voltage	400	V <sub>P</sub>
Load Current	100	mA <sub>rms</sub> / mA <sub>DC</sub>
On-Resistance (max)	35	Ω
LED Current to Operate	2	mA

#### **Features**

- 1500V<sub>rms</sub> Input/Output Isolation
   Low Drive Power Requirements
- · High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 4-Pin SOP Package
- Tape & Reel Version Available
- Flammability Rating UL 94 V-0

# **Applications**

- Telecommunications
  - Telecom Switching
  - Tip/Ring Circuits
  - · Modem Switching (Laptop, Notebook, Pocket
  - Hook Switch
  - Dial Pulsing
  - Ground Start
  - Ringing Injection
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- · Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

## **Description**

CPC1125N is a miniature normally-closed (1-Form-B), single-pole solid state relay. It uses IXYS Integrated Circuits' patented, optically coupled, OptoMOS architecture to provide 1500V<sub>rms</sub> of input/output isolation in a small 4-pin SOP package.

CPC1125N uses IXYS Integrated Circuits' state of the art double-molded vertical construction packaging to produce one of the world's smallest relays. It is ideal for replacing larger, less-reliable reed and electromechanical relays.

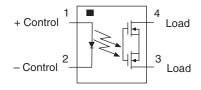
# **Approvals**

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: Certificate available on our website

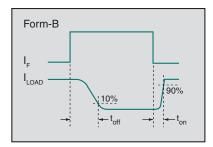
# **Ordering Information**

Part #	Description
CPC1125N	4-Pin SOP (100/tube)
CPC1125NTR	4-Pin SOP (2000/reel)

#### Pin Configuration



**Switching Characteristics of** Normally-Closed Devices











# Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	400	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	Α
Input Power Dissipation <sup>1</sup>	150	mW
Total Power Dissipation <sup>2</sup>	400	mW
Isolation Voltage, Input to Output	1500	V <sub>rms</sub>
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>&</sup>lt;sup>1</sup> Derate linearly 1.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

# Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics					'	
Load Current						
Continuous 1	I <sub>F</sub> =0mA	IL	-	-	100	$mA_{rms} / mA_{DC}$
Peak	t =10ms	I <sub>LPK</sub>	-	-	±350	mA <sub>P</sub>
On-Resistance <sup>2</sup>	I <sub>L</sub> =100mA	R <sub>ON</sub>	-	26	35	Ω
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	0.31	2	mo
Turn-Off		t <sub>off</sub>	-	0.30	2	— ms
Off-State Leakage Current	V <sub>L</sub> =400V, I <sub>F</sub> =2mA	I <sub>LEAK</sub>	-	-	5	μΑ
Output Capacitance	I <sub>F</sub> =2mA, V <sub>L</sub> = 50V, f=1MHz	C <sub>OUT</sub>	-	6	-	pF
Input Characteristics						
Input Control Current to Activate 3	I <sub>L</sub> =100mA	I <sub>F</sub>	-	-	2	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.1	-	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	$V_{F}$	0.9	1.2	1.5	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μΑ
Common Characteristics	<u>'</u>			•	•	
Capacitance, Input to Output	V <sub>IO</sub> =0V, f=1MHz	$C_{IO}$	-	1	-	pF

Load current derates linearly from 100mA @ 25°C to 60mA @ 85°C. Measurement taken within 1 second of on-time.

<sup>&</sup>lt;sup>2</sup> Derate linearly 3.33 mw / °C

For applications requiring high temperature operation (greater than 60°C) a minimum LED drive current of 4mA is recommended.



1.2

1.0

-40 -20

I<sub>E</sub>=10mA I = 5mA

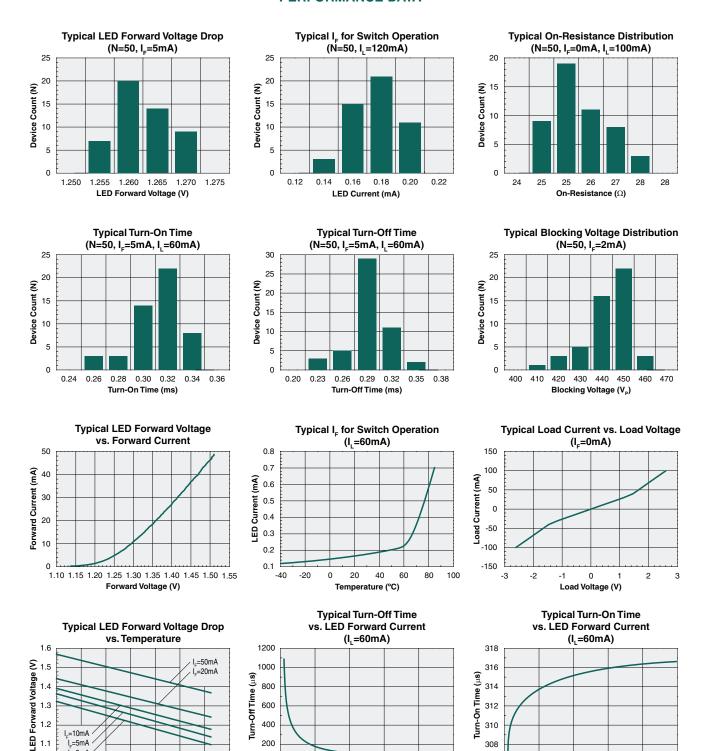
I\_=2mA

40

Temperature (°C)

80 100

#### **PERFORMANCE DATA\***



\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

20

30

LED Current (mA)

40

50

310

308

306

0

10

20

LED Current (mA)

30

40

50

400

200

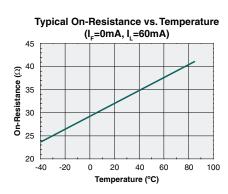
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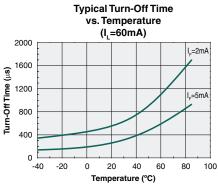
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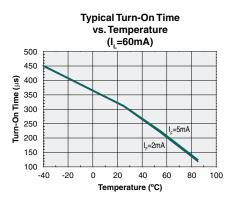
10

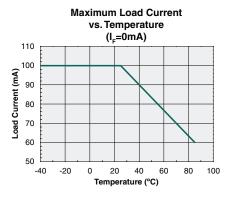


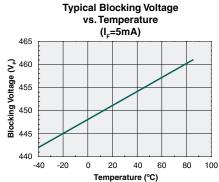
## **PERFORMANCE DATA\***

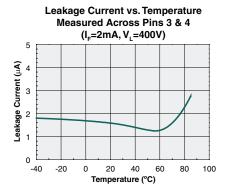


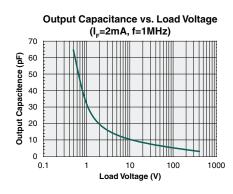


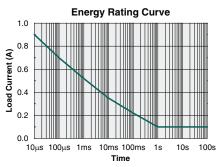














# **Manufacturing Information**

# **Moisture Sensitivity**

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
CPC1125N	MSL 3

# **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

## **Soldering Profile**

Provided in the table below is the Classification Temperature ( $T_C$ ) of this product and the maximum dwell time the body temperature of this device may be ( $T_C$  - 5)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature (T <sub>c</sub> )	Dwell Time (t <sub>p</sub> )	Max Reflow Cycles
CPC1125N	260°C	30 seconds	3

## **Board Wash**

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



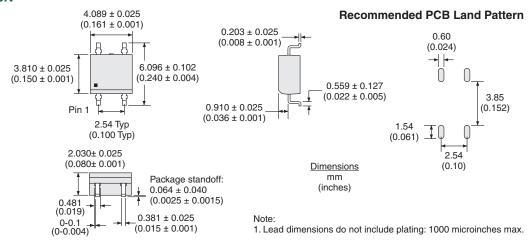




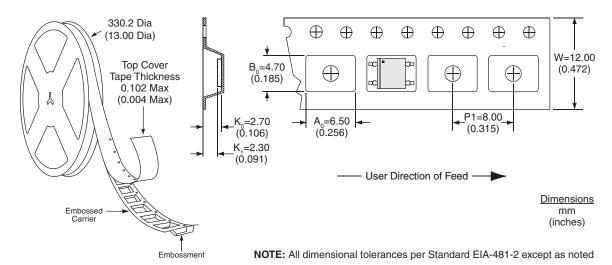


#### **MECHANICAL DIMENSIONS**

#### **CPC1125N**



#### **CPC1125NTR Tape & Reel**



## For additional information please visit our website at: www.ixysic.com

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Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

# Данный компонент на территории Российской Федерации Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

# http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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